

LINEAR TECHNOLOGY MATERIALS DECLARATION

LT1468CDD-2#TRPBF

(Engineering Calculation)

DFN 3mm X 3mm Exp. Pad

(printed on: 2014-01-19 22:05:08)

TOTAL MASS (g): 0.022815

COMPONENT MATERIAL	VENDOR/INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL Pkg.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001809	1000000	79286.6228125		
Die Coat	Dow Corning	Silicone	69830-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.009350	975000	409811.34375		
		Iron (Fe)	7439-89-6	0.000230	24000	10080.9208984		
		Phosphorus (P)	7723-14-0	0.000003	300	131.490280151		
		Zinc (Zn)	7440-66-6	0.000007	700	306.810638428		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead Frame Total:				0.009596	1000000	420336.5625
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000437	1000000	19170.203125		
		External Plating Total:				0.000437	1000000	19170.203125
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000218	1000000	9554.95996094		
		Internal Plating Total:				0.000218	1000000	9554.95996094
Die Attach	ELECTRICALLY INSULATING ADHESIVE	Silver (Ag)	7440-22-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000019	1000000	832.77166748		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000056	300000	2454.48510742		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000112	600000	4968.97021484		
		Die Attach Total:				0.000187	1000000	8196.2265625
		Encapsulation	MULTIAROMATIC RESIN B/SB-FREE	Resin (EP)		0.001368	130000	59999.5625
Bromine (Br)	40039-93-8			0.000000	0	0		
Silica (SiO2)	60676-86-0			0.000047	860000	396530.8125		
Antimony Trioxide (Sb2O3)	1309-64-4			0.000000	0	0		
Metal Hydroxide				0.000000	0	0		
Carbon Black (C)	1333-86-4			0.000105	10000	4602.15917969		
Encapsulation Total:				0.010520	1000000	461092.53125		
Bond Wire Estimated	APW/TANAKA/Kn	Gold (Au)	7440-57-5	0.000054	1000000	2366.82470703		

TOTAL MASS (g): 0.022815